LM4665 Boomer® Audio Power Amplifier Series Filterless High Efficiency 1W Switching Audio Amplifier

Check for Samples: LM4665

FEATURES

- No Output Filter Required for Inductive Transducers
- Selectable Gain of 6dB (2V/V) or 12dB (4V/V)
- Very Fast Turn On Time: 5ms (typ)
- User Selectable Shutdown High or Low Logic Level
- Minimum External Components
- "Click and Pop" Suppression Circuitry
- Micro-Power Shutdown Mode
- Short Circuit Protection
- DSBGA, WSON, and VSSOP Packages (No Heat Sink Required)

APPLICATIONS

- Mobile Phones
- PDAs
- Portable Electronic Devices

KEY SPECIFICATIONS

- Efficiency at 100mW into 8Ω Transducer 75%(typ)
- Efficiency at 400mW into 8Ω Transducer 80%(typ)
- Total Quiescent Power Supply Current (3V) 3mA(typ)
- Total Shutdown Power Supply Current (3V) 0.01µA(typ)
- Single Supply Range (VSSOP & WSON) 2.7V to 5.5V
- Single Supply Range (DSBGA) (Note 11) 2.7V to 3.8V

DESCRIPTION

The LM4665 is a fully integrated single-supply high efficiency switching audio amplifier. It features an innovative modulator that eliminates the LC output filter used with typical switching amplifiers. Eliminating the output filter reduces parts count, simplifies circuit design, and reduces board area. The LM4665 processes analog inputs with a delta-sigma modulation technique that lowers output noise and THD when compared to conventional pulse width modulators.

The LM4665 is designed to meet the demands of mobile phones and other portable communication devices. Operating on a single 3V supply, it is capable of driving 8Ω transducer loads at a continuous average output of 400mW with less than 2%THD+N.

The LM4665 has high efficiency with an 8Ω transducer load compared to a typical Class AB amplifier. With a 3V supply, the IC’s efficiency for a 100mW power level is 75%, reaching 80% at 400mW output power.

The LM4665 features a low-power consumption shutdown mode. Shutdown may be enabled by either a logic high or low depending on the mode selection. Connecting the Shutdown Mode pin to either VDD (high) or GND (low) enables the Shutdown pin to be driven in a likewise manner to activate shutdown.

The LM4665 has fixed selectable gain of either 6dB or 12dB. The LM4665 has short circuit protection against a short from the outputs to VDD, GND or across the outputs.
Typical Application

Figure 1. Typical Audio Amplifier Application Circuit

Connection Diagram

Figure 2. VSSOP Package – Top View
See Package Number DGS

Figure 3. 9 Bump DSBGA Package – Top View
See Package Number YZR0009

Figure 4. WSON Package – Top View
See Package Number NGZ
These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

**Absolute Maximum Ratings**

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Specification</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply Voltage</td>
<td>6.0V</td>
</tr>
<tr>
<td>Storage Temperature</td>
<td>−65°C to +150°C</td>
</tr>
<tr>
<td>Voltage at Any Input Pin</td>
<td>$V_{DD} + 0.3V \geq V \geq GND - 0.3V$</td>
</tr>
<tr>
<td>Power Dissipation</td>
<td>Internally Limited</td>
</tr>
<tr>
<td>ESD Susceptibility</td>
<td>2.0kV</td>
</tr>
<tr>
<td>ESD Susceptibility</td>
<td>200V</td>
</tr>
<tr>
<td>Junction Temperature ($T_J$)</td>
<td>150°C</td>
</tr>
<tr>
<td>Thermal Resistance</td>
<td></td>
</tr>
<tr>
<td>$\theta_{JA}$ (VSSOP)</td>
<td>190°C/W</td>
</tr>
<tr>
<td>$\theta_{JC}$ (VSSOP)</td>
<td>56°C/W</td>
</tr>
<tr>
<td>$\theta_{JA}$ (DSBGA)</td>
<td>180°C/W</td>
</tr>
<tr>
<td>$\theta_{JA}$ (WSON)</td>
<td>63°C/W</td>
</tr>
<tr>
<td>$\theta_{JC}$ (WSON)</td>
<td>12°C/W</td>
</tr>
</tbody>
</table>

**Soldering Information**

See the AN-1112 Application Report

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(1) All voltages are measured with respect to the ground pin, unless otherwise specified.
(2) **Absolute Maximum Ratings** indicate limits beyond which damage to the device may occur. **Operating Ratings** indicate conditions for which the device is functional, but do not ensure specific performance limits. **Electrical Characteristics** state DC and AC electrical specifications under particular test conditions which ensure specific performance limits. This assumes that the device is within the **Operating Ratings**. Specifications are not ensured for parameters where no limit is given, however, the typical value is a good indication of device performance.
(3) If Military/Aerospace specified devices are required, please contact the TI Sales Office/ Distributors for availability and specifications.
(4) The maximum power dissipation must be derated at elevated temperatures and is dictated by $T_{J\text{MAX}}, \theta_{JA}$, and the ambient temperature $T_A$. The maximum allowable power dissipation is $P_{DMAX} = (T_{J\text{MAX}} - T_A)/\theta_{JA}$ or the number given in Absolute Maximum Ratings, whichever is lower. For the LM4665, $T_{J\text{MAX}} = 150°C$. See the Efficiency and Power Dissipation versus Output Power curves for more information.
(5) Human body model, 100 pF discharged through a 1.5 kΩ resistor.
(7) The exposed-DAP of the LDA10B package should be electrically connected to GND.

**Operating Ratings**

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Specification</th>
</tr>
</thead>
<tbody>
<tr>
<td>Temperature Range</td>
<td>$-40°C \leq T_A \leq 85°C$</td>
</tr>
<tr>
<td>Supply Voltage (DGS &amp; NGZ)</td>
<td>$2.7V \leq V_{DD} \leq 5.5V$</td>
</tr>
<tr>
<td>Supply Voltage (YZR0009) (Note11)</td>
<td>$2.7V \leq V_{DD} \leq 3.8V$</td>
</tr>
</tbody>
</table>

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(1) **Absolute Maximum Ratings** indicate limits beyond which damage to the device may occur. **Operating Ratings** indicate conditions for which the device is functional, but do not ensure specific performance limits. **Electrical Characteristics** state DC and AC electrical specifications under particular test conditions which ensure specific performance limits. This assumes that the device is within the **Operating Ratings**. Specifications are not ensured for parameters where no limit is given, however, the typical value is a good indication of device performance.
Electrical Characteristics \( V_{DD} = 5V \)

The following specifications apply for \( V_{DD} = 5V, R_L = 8\Omega + 33\mu H \), measurement bandwidth is \(<10Hz - 22kHz\) unless otherwise specified. Limits apply for \( T_A = 25^\circ C \).

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>LM4665</th>
</tr>
</thead>
</table>
| \( I_{DD} \) | Quiescent Power Supply Current | \( V_{IN} = 0V, \) No Load \( V_{IN} = 0V, 8\Omega + 22\mu H \) Load | 14 mA  
14.5 mA |
| \( I_{SD} \) | Shutdown Current | \( V_{SD} = V_{SD} \) \( V_{SD} \) \( V_{DD} \) Mode \( (7) \) | 0.1 \( \mu A \) (max)  
1.2 V (min)  
1.1 V (max) |
| \( V_{SDIH} \) | Shutdown Voltage Input High | \( V_{SD} \) Mode = \( V_{DD} \) | 1.2 V (min)  
1.1 V (max) |
| \( V_{SDIL} \) | Shutdown Voltage Input Low | \( V_{SD} \) Mode = \( V_{DD} \) | 1.2 V (min)  
1.1 V (max) |
| \( A_V \) | Closed Loop Gain | \( V_{Gain \ Select} = V_{DD} \) | 6 dB (min)  
5.5 dB (max) |
| \( V_{OS} \) | Output Offset Voltage | | 10 mV |
| \( T_{WU} \) | Wake-up Time | | 5 ms |
| \( P_o \) | Output Power | \( THD+N = 3\% \) (max), \( f_{IN} = 1kHz \) | 1.4 W |
| \( THD+N \) | Total Harmonic Distortion+Noise | \( P_{O} = 400mW_{RMS}, f_{IN} = 1kHz \) | 0.8 \% |
| \( R_{IN} \) | Differential Input Resistance | \( V_{Gain \ Select} = V_{DD}, \) Gain = 6dB \( V_{Gain \ Select} = GND, \) Gain = 12dB | 100 k\Omega  
65 k\Omega |
| \( PSRR \) | Power Supply Rejection Ratio | \( V_{Ripple} = 100mV_{RMS}, f_{Ripple} = 217Hz, \) \( A_V = 6dB \) Inputs Terminated | 52 dB |
| \( CMRR \) | Common Mode Rejection Ratio | \( V_{Ripple} = 100mV_{RMS}, f_{Ripple} = 217Hz, \) \( A_V = 6dB \) | 43 dB |
| \( e_{N} \) | Output Noise Voltage | A-Weighted filter, \( V_{IN} = 0V \) | 350 \( \mu V \) |

(1) All voltages are measured with respect to the ground pin, unless otherwise specified.
(2) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which ensure specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not ensured for parameters where no limit is given, however, the typical value is a good indication of device performance.
(3) The LM4665 in the DSBGA package (NGZ) has an operating range of 2.7V - 3.8V for 8\Omega speaker loads. The supply range may be increased as speaker impedance is increased. It is not recommended that 4\Omega loads be used with the DSBGA package. To increase the supply voltage operating range, see Figure 31 and INCREASING SUPPLY VOLTAGE RANGE in the Application Information section for more information.
(4) Typical specifications are specified at 25\(^\circ\)C and represent the parametric norm.
(5) Tested limits are specified to TI's AOQL (Average Outgoing Quality Level).
(6) Datasheet min/max specification limits are ensured by design, test, or statistical analysis.
(7) Shutdown current is measured in a normal room environment. Exposure to direct sunlight will increase \( I_{SD} \) by a maximum of 2\( \mu A \). The Shutdown Mode pin should be connected to \( V_{DD} \) or GND and the Shutdown pin should be driven as close as possible to \( V_{DD} \) or GND for minimum shutdown current and the best THD performance in PLAY mode. See the Application Information section under SHUTDOWN FUNCTION for more information.
Electrical Characteristics $V_{DD} = 3V^{(1)(2)}$

The following specifications apply for $V_{DD} = 3V$, and $R_L = 8\Omega + 33\mu H$, measurement bandwidth is $<10Hz - 22kHz$ unless otherwise specified. Limits apply for $T_A = 25°C$.

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>LM4665</th>
<th>Units (Limits)</th>
</tr>
</thead>
<tbody>
<tr>
<td>$I_{DD}$</td>
<td>Quiescent Power Supply Current</td>
<td>$V_{IN} = 0V$, No Load, $V_{IN} = 0V$, 8Ω + 22µH Load</td>
<td>3.0</td>
<td>mA (max)</td>
</tr>
<tr>
<td>$I_{SD}$</td>
<td>Shutdown Current</td>
<td>$V_{SD} = V_{SD\ mode}^{(6)}$</td>
<td>0.01</td>
<td>µA (max)</td>
</tr>
<tr>
<td>$V_{SDIH}$</td>
<td>Shutdown Voltage Input High</td>
<td>$V_{SD\ mode} = V_{DD}$</td>
<td>1.0</td>
<td>V (min)</td>
</tr>
<tr>
<td>$V_{SDIL}$</td>
<td>Shutdown Voltage Input Low</td>
<td>$V_{SD\ mode} = V_{DD}$</td>
<td>0.8</td>
<td>V (max)</td>
</tr>
<tr>
<td>$V_{GSIH}$</td>
<td>Gain Select Input High</td>
<td>$V_{Gain\ Select} = V_{DD}$</td>
<td>1.0</td>
<td>V (min)</td>
</tr>
<tr>
<td>$V_{GSIL}$</td>
<td>Gain Select Input Low</td>
<td>$V_{Gain\ Select} = V_{DD}$</td>
<td>0.8</td>
<td>V (max)</td>
</tr>
<tr>
<td>$A_{V}$</td>
<td>Closed Loop Gain</td>
<td>$V_{Gain\ Select} = V_{DD}$</td>
<td>6</td>
<td>dB (min)</td>
</tr>
<tr>
<td>$A_{V}$</td>
<td>Closed Loop Gain</td>
<td>$V_{Gain\ Select} = GND$</td>
<td>12</td>
<td>dB (max)</td>
</tr>
<tr>
<td>$V_{OS}$</td>
<td>Output Offset Voltage</td>
<td></td>
<td>10</td>
<td>mV</td>
</tr>
<tr>
<td>$T_{WU}$</td>
<td>Wake-up Time</td>
<td></td>
<td>5</td>
<td>ms</td>
</tr>
<tr>
<td>$P_o$</td>
<td>Output Power</td>
<td>THD+N = 2% (max), $f_{IN} = 1kHz$</td>
<td>400</td>
<td>mW (min)</td>
</tr>
<tr>
<td>$T_{H} + N$</td>
<td>Total Harmonic Distortion + Noise</td>
<td>$P_{O} = 100mW_{RMS}$, $f_{IN} = 1kHz$</td>
<td>0.4</td>
<td>% (max)</td>
</tr>
<tr>
<td>$R_{IN}$</td>
<td>Differential Input Resistance</td>
<td>$V_{Gain\ Select} = V_{DD}$, Gain = 6dB</td>
<td>100</td>
<td>kΩ</td>
</tr>
<tr>
<td>$R_{IN}$</td>
<td>Differential Input Resistance</td>
<td>$V_{Gain\ Select} = GND$, Gain = 12dB</td>
<td>65</td>
<td>kΩ</td>
</tr>
<tr>
<td>PSRR</td>
<td>Power Supply Rejection Ratio</td>
<td>$V_{Ripple} = 100mV_{RMS}$, $f_{Ripple} = 217Hz$, $A_{V} = 6dB$, Inputs Terminated</td>
<td>52</td>
<td>dB</td>
</tr>
<tr>
<td>CMRR</td>
<td>Common Mode Rejection Ratio</td>
<td>$V_{Ripple} = 100mV_{RMS}$, $f_{Ripple} = 217Hz$, $A_{V} = 6dB$</td>
<td>39</td>
<td>dB</td>
</tr>
<tr>
<td>$e_{N}$</td>
<td>Output Noise Voltage</td>
<td>A-Weighted filter, $V_{IN} = 0V$</td>
<td>350</td>
<td>µV</td>
</tr>
</tbody>
</table>

(1) All voltages are measured with respect to the ground pin, unless otherwise specified.
(2) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which ensure specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not ensured for parameters where no limit is given, however, the typical value is a good indication of device performance.
(3) Typical specifications are specified at 25°C and represent the parametric norm.
(4) Tested limits are specified to TI’s AOQL (Average Outgoing Quality Level).
(5) Datasheet min/max specification limits are ensured by design, test, or statistical analysis.
(6) Shutdown current is measured in a normal room environment. Exposure to direct sunlight will increase $I_{SD}$ by a maximum of 2µA. The Shutdown Mode pin should be connected to $V_{DD}$ or GND and the Shutdown pin should be driven as close as possible to $V_{DD}$ or GND for minimum shutdown current and the best THD performance in PLAY mode. See the Application Information section under SHUTDOWN FUNCTION for more information.

External Components Description

(Figure 1)

<table>
<thead>
<tr>
<th>Components</th>
<th>Functional Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1. $C_S$</td>
<td>Supply bypass capacitor which provides power supply filtering. Refer to the POWER SUPPLY BYPASSING section for information concerning proper placement and selection of the supply bypass capacitor.</td>
</tr>
</tbody>
</table>
Typical Performance Characteristics

THD+N vs Frequency

- $V_{DD} = 5V, R_L = 8\Omega + 33\mu H$
  - $P_{OUT} = 400mW, 30kHz$ BW

- $V_{DD} = 3V, R_L = 8\Omega + 33\mu H$
  - $P_{OUT} = 100mW, 30kHz$ BW

Figure 5. Figure 6.

THD+N vs Frequency

- $V_{DD} = 3.3V, R_L = 4\Omega + 33\mu H$
  - $P_{OUT} = 300mW, 30kHz$ BW

- $f = 1kHz, 22kHz$ BW

Figure 7. Figure 8.

THD+N vs Power Out

- $V_{DD} = 3V, R_L = 8\Omega + 33\mu H$
  - $f = 1kHz, 22kHz$ BW

- $V_{DD} = 3.3V, R_L = 4\Omega + 33\mu H$
  - $f = 1kHz, 22kHz$ BW

Figure 9. Figure 10.
Typical Performance Characteristics (continued)

THD+N vs Common-Mode Voltage

\[ V_{DD} = 5V, R_L = 8\Omega + 33\mu H, f = 1kHz \]
\[ P_{OUT} = 400mW, 22kHz BW \]

\[ V_{DD} = 3V, R_L = 8\Omega + 33\mu H, f = 1kHz \]
\[ P_{OUT} = 100mW, 22kHz BW \]

**Figure 11.**

CMRR vs Frequency

\[ V_{CM} = 100mVRMS Sine Wave, 80kHz BW \]

**Figure 13.**

PSRR vs DC Common-Mode Voltage

\[ V_{Ripple} = 100mVRMS, f_{Ripple} = 217Hz Sine Wave \]

**Figure 15.**
Typical Performance Characteristics (continued)

**PSRR vs Frequency**

\[V_{DD} = 5V, R_L = 8\Omega + 33\mu H\]

\[V_{CM} = 100mV_{RMS} \text{Sine Wave, 22kHz BW}\]

**Efficiency (top trace) and Power Dissipation (bottom trace) vs Output Power**

\[V_{DD} = 5V, R_L = 8\Omega + 33\mu H, f = 1kHz, \text{THD} < 3\%\]

\[V_{DD} = 3V, R_L = 8\Omega + 33\mu H, f = 1kHz, \text{THD} < 2\%\]

**Gain Threshold Voltages**

\[V_{DD} = 3V - 5V\]
Typical Performance Characteristics (continued)

Output Power vs Supply Voltage
\[ R_L = 16\Omega + 33\mu H, f = 1kHz \]

Figure 23.

Output Power vs Supply Voltage
\[ R_L = 8\Omega + 33\mu H, f = 1kHz \]

Figure 24.

Output Power vs Supply Voltage
\[ R_L = 4\Omega + 33\mu H, f = 1kHz \]

Figure 25.

Shutdown Hysteresis Voltage
\[ V_{DD} = 5V, SD \text{ Mode} = GND (SD Low) \]

Figure 26.

Shutdown Hysteresis Voltage
\[ V_{DD} = 3V, SD \text{ Mode} = GND (SD Low) \]

Figure 27.

Shutdown Hysteresis Voltage
\[ V_{DD} = 5V, SD \text{ Mode} = GND (SD High) \]

Figure 28.
Typical Performance Characteristics (continued)

Shutdown Hysteresis Voltage
$V_{DD} = 3V$, SD Mode = GND (SD High)

![Shutdown Hysteresis Voltage Graph](image1)

Supply Current vs Supply Voltage
$R_L = 8\Omega + 33\mu\text{H}$

![Supply Current vs Supply Voltage Graph](image2)

Figure 29.
Figure 30.
APPLICATION INFORMATION

GENERAL AMPLIFIER FUNCTION

The output signals generated by the LM4665 consist of two, BTL connected, output signals that pulse momentarily from near ground potential to $V_{DD}$. The two outputs can pulse independently with the exception that they both may never pulse simultaneously as this would result in zero volts across the BTL load. The minimum width of each pulse is approximately 160ns. However, pulses on the same output can occur sequentially, in which case they are concatenated and appear as a single wider pulse to achieve an effective 100% duty cycle. This results in maximum audio output power for a given supply voltage and load impedance. The LM4665 can achieve much higher efficiencies than class AB amplifiers while maintaining acceptable THD performance.

The short (160ns) drive pulses emitted at the LM4665 outputs means that good efficiency can be obtained with minimal load inductance. The typical transducer load on an audio amplifier is quite reactive (inductive). For this reason, the load can act as it's own filter, so to speak. This "filter-less" switching amplifier/transducer load combination is much more attractive economically due to savings in board space and external component cost by eliminating the need for a filter.

POWER DISSIPATION AND EFFICIENCY

In general terms, efficiency is considered to be the ratio of useful work output divided by the total energy required to produce it with the difference being the power dissipated, typically, in the IC. The key here is "useful" work. For audio systems, the energy delivered in the audible bands is considered useful including the distortion products of the input signal. Sub-sonic (DC) and super-sonic components (>22kHz) are not useful. The difference between the power flowing from the power supply and the audio band power being transduced is dissipated in the LM4665 and in the transducer load. The amount of power dissipation in the LM4665 is very low. This is because the ON resistance of the switches used to form the output waveforms is typically less than 0.25Ω. This leaves only the transducer load as a potential "sink" for the small excess of input power over audio band output power. The LM4665 dissipates only a fraction of the excess power requiring no additional PCB area or copper plane to act as a heat sink.

DIFFERENTIAL AMPLIFIER EXPLANATION

As logic supply voltages continue to shrink, designers are increasingly turning to differential analog signal handling to preserve signal to noise ratios with restricted voltage swing. The LM4665 is a fully differential amplifier that features differential input and output stages. A differential amplifier amplifies the difference between the two input signals. Traditional audio power amplifiers have typically offered only single-ended inputs resulting in a 6dB reduction in signal to noise ratio relative to differential inputs. The LM4665 also offers the possibility of DC input coupling which eliminates the two external AC coupling, DC blocking capacitors. The LM4665 can be used, however, as a single ended input amplifier while still retaining it's fully differential benefits. In fact, completely unrelated signals may be placed on the input pins. The LM4665 simply amplifies the difference between the signals. A major benefit of a differential amplifier is the improved common mode rejection ratio (CMRR) over single input amplifiers. The common-mode rejection characteristic of the differential amplifier reduces sensitivity to ground offset related noise injection, especially important in high noise applications.

PCB LAYOUT CONSIDERATIONS

As output power increases, interconnect resistance (PCB traces and wires) between the amplifier, load and power supply create a voltage drop. The voltage loss on the traces between the LM4665 and the load results is lower output power and decreased efficiency. Higher trace resistance between the supply and the LM4665 has the same effect as a poorly regulated supply, increase ripple on the supply line also reducing the peak output power. The effects of residual trace resistance increases as output current increases due to higher output power, decreased load impedance or both. To maintain the highest output voltage swing and corresponding peak output power, the PCB traces that connect the output pins to the load and the supply pins to the power supply should be as wide as possible to minimize trace resistance.
The rising and falling edges are necessarily short in relation to the minimum pulse width (160ns), having approximately 2ns rise and fall times, typical, depending on parasitic output capacitance. The inductive nature of the transducer load can also result in overshoot on one or both edges, clamped by the parasitic diodes to GND and \( V_{DD} \) in each case. From an EMI standpoint, this is an aggressive waveform that can radiate or conduct to other components in the system and cause interference. It is essential to keep the power and output traces short and well shielded if possible. Use of ground planes, beads, and micro-strip layout techniques are all useful in preventing unwanted interference.

**POWER SUPPLY BYPASSING**

As with any power amplifier, proper supply bypassing is critical for low noise performance and high power supply rejection ratio (PSRR). The capacitor (\( C_S \)) location should be as close as possible to the LM4665. Typical applications employ a voltage regulator with a 10\( \mu \)F and a 0.1\( \mu \)F bypass capacitors that increase supply stability. These capacitors do not eliminate the need for bypassing on the supply pin of the LM4665. A 1\( \mu \)F tantalum capacitor is recommended.

**SHUTDOWN FUNCTION**

In order to reduce power consumption while not in use, the LM4665 contains shutdown circuitry that reduces current draw to less than 0.01\( \mu \)A. In addition, the LM4665 contains a Shutdown Mode pin allowing the designer to designate whether the shutdown circuitry is activated by either a High level logic signal or a Low level logic signal. The Shutdown Mode pin should be permanently connected to either GND (Low) or \( V_{DD} \) (High). The LM4665 may then be placed into shutdown by toggling the Shutdown pin to the same state as the Shutdown Mode pin. For simplicity's sake, this is called "Shutdown same", as the LM4665 enters into a shutdown state whenever the two pins are in the same logic state. The trigger point for either shutdown high or shutdown low is shown as a typical value in the Electrical Characteristics Tables and in the Shutdown Hysteresis Voltage graphs found in the Typical Performance Characteristics section. It is best to switch between ground and supply for minimum current usage while in the shutdown state. While the LM4665 may be disabled with shutdown voltages in between ground and supply, the idle current will be greater than the typical 0.01\( \mu \)A value. Increased THD may also be observed with voltages greater than GND and less than \( V_{DD} \) on the Shutdown pin when in PLAY mode.

The LM4665 has an internal resistor connected between the Shutdown Mode and Shutdown pins. The purpose of this resistor is to eliminate any unwanted state changes when the Shutdown pin is floating, as long as the Shutdown Mode pin is connected to GND or \( V_{DD} \). When the Shutdown Mode pin is properly connected, the LM4665 will enter the shutdown state when the Shutdown pin is left floating or if not floating, when the shutdown voltage has crossed the corresponding threshold for the logic level assigned by the Shutdown Mode pin voltage. To minimize the supply current while in the shutdown state, the Shutdown pin should be driven to the same potential as the Shutdown Mode pin or left floating. The amount of additional current due to the internal shutdown resistor can be found by Equation 1 below.

\[
(V_{SD\ Mode} - V_{SD}) / 60k\Omega
\]

With only a 0.5V difference between the Shutdown Mode voltage and the Shutdown voltage an additional 8.3\( \mu \)A of current will be drawn while in the shutdown state.

**GAIN SELECTION FUNCTION**

The LM4665 has fixed selectable gain to minimize external components, increase flexibility and simplify design. For a differential gain of 6dB (2V/V), the Gain Select pin should be permanently connected to \( V_{DD} \) or driven to a logic high level. For a differential gain of 12dB (4V/V), the Gain Select pin should be permanently connected to GND or driven to a logic low level. The gain of the LM4665 can be switched while the amplifier is in PLAY mode driving a load with a signal without damage to the IC. The voltage on the Gain Select pin should be switched quickly between GND (logic low) and \( V_{DD} \) (logic high) to eliminate any possible audible artifacts from appearing at the output. For typical threshold voltages for the Gain Select function, refer to the Gain Threshold Voltages graph in the Typical Performance Characteristics section.

**INCREASING SUPPLY VOLTAGE RANGE**

When using the DSBGA package (YZR0009), the operating supply voltage range is 2.7V - 3.8V with an 8\( \Omega \) speaker load. To increase the operating supply voltage range, four Schottky diodes (\( D_1 \) - \( D_4 \)) can be used to control the over and undershoot of the output pulse waveform (See Figure 31 below). To reduce THD+N, small value capacitors in the range of 10\( \mu \)F - 33\( \mu \)F (\( C_{W1} \) & \( C_{W2} \)) can also be added as needed. The diodes should be placed as close to the DSBGA package as possible.
Figure 31. Increased Supply Voltage Operating Range for the DSBGA Package

SINGLE-ENDED CIRCUIT CONFIGURATIONS

Figure 32. Single-Ended Input, Shutdown High and Gain of 6dB Configuration
Figure 33. Single-Ended Input, Shutdown High and Gain of 12dB Configuration

Figure 34. Single-Ended Input, Shutdown Low and Gain of 6dB Configuration
Figure 35. Single-Ended Input, Shutdown Low and Gain of 12dB Configuration
In addition to the minimal parts required for the application circuit, a measurement filter is provided on the evaluation circuit board so that conventional audio measurements can be conveniently made without additional equipment. This is a balanced input / grounded differential output low pass filter with a 3dB frequency of approximately 35kHz and an on board termination resistor of 300Ω (see schematic). Note that the capacitive load elements are returned to ground. This is not optimal for common mode rejection purposes, but due to the independent pulse format at each output there is a significant amount of high frequency common mode component on the outputs. The grounded capacitive filter elements attenuate this component at the board to reduce the high frequency CMRR requirement placed on the analysis instruments.

Even with the grounded filter the audio signal is still differential, necessitating a differential input on any analysis instrument connected to it. Most lab instruments that feature BNC connectors on their inputs are NOT differential responding because the ring of the BNC is usually grounded.

The commonly used Audio Precision analyzer is differential, but its ability to accurately reject fast pulses of 160nS width is questionable necessitating the on board measurement filter. When in doubt or when the signal needs to be single-ended, use an audio signal transformer to convert the differential output to a single ended output. Depending on the audio transformer’s characteristics, there may be some attenuation of the audio signal which needs to be taken into account for correct measurement of performance.

Measurements made at the output of the measurement filter suffer attenuation relative to the primary, unfiltered outputs even at audio frequencies. This is due to the resistance of the inductors interacting with the termination resistor (300Ω) and is typically about -0.35dB (4%). In other words, the voltage levels (and corresponding power levels) indicated through the measurement filter are slightly lower than those that actually occur at the load placed on the unfiltered outputs. This small loss in the filter for measurement gives a lower output power reading than what is really occurring on the unfiltered outputs and its load.
Figure 36. Composite View

Figure 37. Silk Screen
Figure 38. Top Layer

Figure 39. Bottom Layer
Figure 40. Composite View

Figure 41. Silk Screen
Figure 44. Composite View

Figure 45. Silk Screen
Figure 46. Top Layer

Figure 47. Bottom Layer
## REVISION HISTORY

### Changes from Revision D (May 2013) to Revision E

<table>
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<td>Changed layout of National Data Sheet to TI format</td>
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</tbody>
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### PACKAGING INFORMATION

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<tr>
<th>Orderable Device</th>
<th>Status (1)</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>Package Qty</th>
<th>Eco Plan (2)</th>
<th>Lead finish/Ball material (6)</th>
<th>MSL Peak Temp (3)</th>
<th>Op Temp (°C)</th>
<th>Device Marking (4/5)</th>
<th>Samples</th>
</tr>
</thead>
<tbody>
<tr>
<td>LM4665ITL/NOPB</td>
<td>ACTIVE</td>
<td>DSBGA</td>
<td>YZR</td>
<td>9</td>
<td>250</td>
<td>RoHS &amp; Green</td>
<td>SNAGCU</td>
<td>Level-1-260C-UNLIM</td>
<td>-40 to 85</td>
<td>G A2</td>
<td>Samples</td>
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</tbody>
</table>

(1) The marketing status values are defined as follows:
- ACTIVE: Product device recommended for new designs.
- LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
- NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
- PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
- OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
- RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
- Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION

<table>
<thead>
<tr>
<th>Device</th>
<th>Package Type</th>
<th>Package Drawing</th>
<th>Pins</th>
<th>SPQ</th>
<th>Reel Diameter (mm)</th>
<th>Reel Width (mm)</th>
<th>A0 (mm)</th>
<th>B0 (mm)</th>
<th>K0 (mm)</th>
<th>P1 (mm)</th>
<th>W (mm)</th>
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</tbody>
</table>

*All dimensions are nominal*

Dimensions:
- **A0**: Dimension designed to accommodate the component width
- **B0**: Dimension designed to accommodate the component length
- **K0**: Dimension designed to accommodate the component thickness
- **W**: Overall width of the carrier tape
- **P1**: Pitch between successive cavity centers

Pocket Quadrants:
- Q1
- Q2
- Q3
- Q4

User Direction of Feed:

Sprocket Holes:

Reel Width (W1):

Cavity:

A0

K0

P1
# PACKAGE MATERIALS INFORMATION

## TAPE AND REEL BOX DIMENSIONS

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<th>SPQ</th>
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*All dimensions are nominal*
D: Max = 1.545 mm, Min = 1.484 mm
E: Max = 1.545 mm, Min = 1.484 mm

NOTES:
A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.
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